

BCR3LM-12LB

Triac

R07DS0063EJ0100

Medium Power Use

Rev.1.00

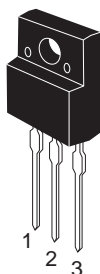
Jul 27, 2010

Features

- $I_T(RMS)$: 3 A
- V_{DRM} : 600 V
- I_{FGTI} , I_{RGTI} , $I_{RGT III}$: 20 mA
- V_{iso} : 1800 V
- The Product guaranteed maximum junction temperature 150°C
- Insulated Type
- Planar Type
- UL Recognized : File No. E223904

Outline

RENESAS Package code: PRSS0003AF-A)
(Package name: TO-220FL)



1. T_1 Terminal
2. T_2 Terminal
3. Gate Terminal

Applications

AC no junction Switching, light dimmer, electronic blanket, Control of household electrical appliance such as electric fans, solenoid driver, small motor control, and other general purpose control applications

Parameter	Symbol	Voltage class	Unit
		12	
Repetitive peak off-state voltage ^{Note1}	V_{DRM}	600	V
Non-repetitive peak off-state voltage ^{Note1}	V_{DSM}	720	V

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	$I_T(RMS)$	3.0	A	Commercial frequency, sine full wave 360°conduction, $T_c = 130^\circ\text{C}$
Surge on-state current	I_{TSM}	30	A	60Hz sinewave 1 full cycle, peak value, non-repetitive
I^2t for fusion	I^2t	3.7	A^2s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P_{GM}	5	W	
Average gate power dissipation	$P_G(AV)$	0.5	W	
Peak gate voltage	V_{GM}	10	V	
Peak gate current	I_{GM}	2	A	
Junction Temperature	T_j	-40 to +150	$^\circ\text{C}$	
Storage temperature	T_{stg}	-40 to +150	$^\circ\text{C}$	
Mass	—	1.5	g	Typical value
Isolation voltage	V_{iso}	1800	V	$T_a = 25^\circ\text{C}$, AC 1 minute, $T_1 \bullet T_2 \bullet G$ terminal to case

Notes: 1. Gate open.

Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Repetitive peak off-state current	I_{DRM}	—	—	2.0	mA	$T_j = 150^\circ\text{C}$, V_{DRM} applied
On-state voltage	V_{TM}	—	—	1.5	V	$T_c = 25^\circ\text{C}$, $I_{\text{TM}} = 4.5\text{ A}$, instantaneous measurement
Gate trigger voltage ^{Note2}	I V_{FGTI}	—	—	1.5	V	$T_j = 25^\circ\text{C}$, $V_D = 6\text{ V}$, $R_L = 6\ \Omega$, $R_G = 330\ \Omega$
	II V_{RGTI}	—	—	1.5	V	
	III V_{RGTIII}	—	—	1.5	V	
Gate trigger current ^{Note2}	I I_{FGTI}	—	—	20	mA	$T_j = 25^\circ\text{C}$, $V_D = 6\text{ V}$, $R_L = 6\ \Omega$, $R_G = 330\ \Omega$
	II I_{RGTI}	—	—	20	mA	
	III I_{RGTIII}	—	—	20	mA	
Gate non-trigger voltage	V_{GD}	0.2/0.1	—	—	V	$T_j = 125^\circ\text{C}/150^\circ\text{C}$, $V_D = 1/2 V_{\text{DRM}}$
Thermal resistance	$R_{\text{th (j-c)}}$	—	—	5.2	$^\circ\text{C/W}$	Junction to case ^{Note3}
Critical-rate of rise of off-state commutation voltage ^{Note4}	$(dv/dt)_c$	5/1	—	—	V/ μs	$T_j = 125^\circ\text{C}/150^\circ\text{C}$

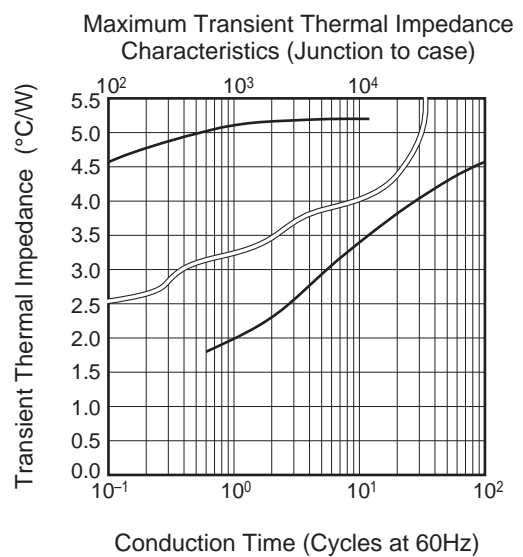
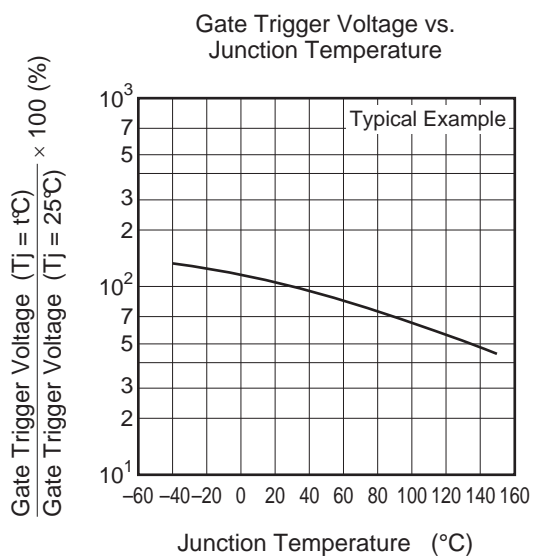
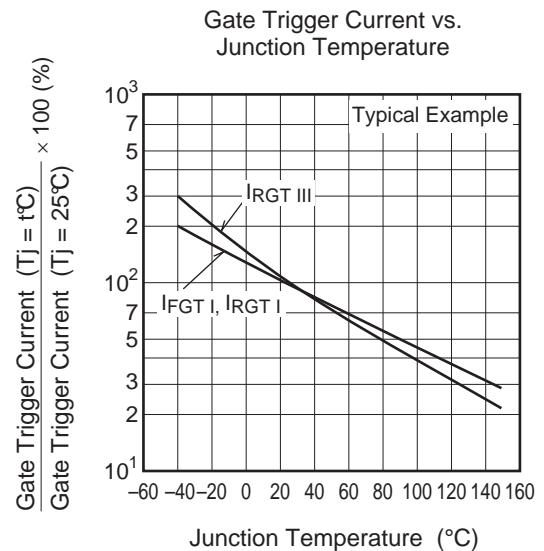
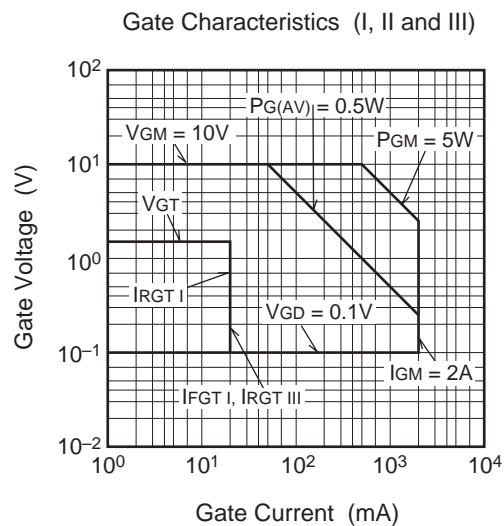
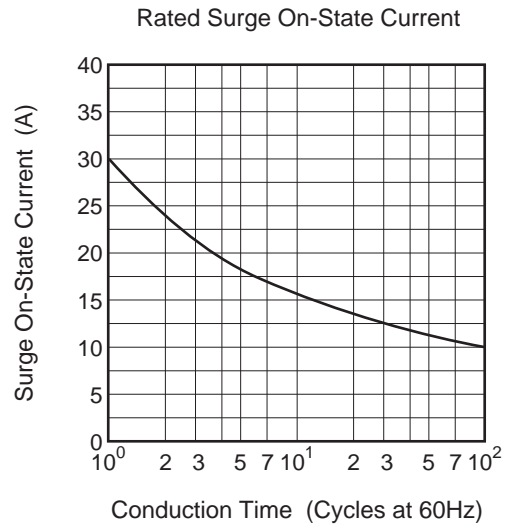
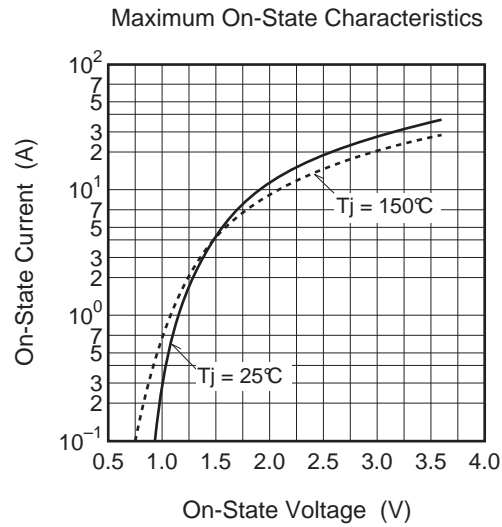
Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

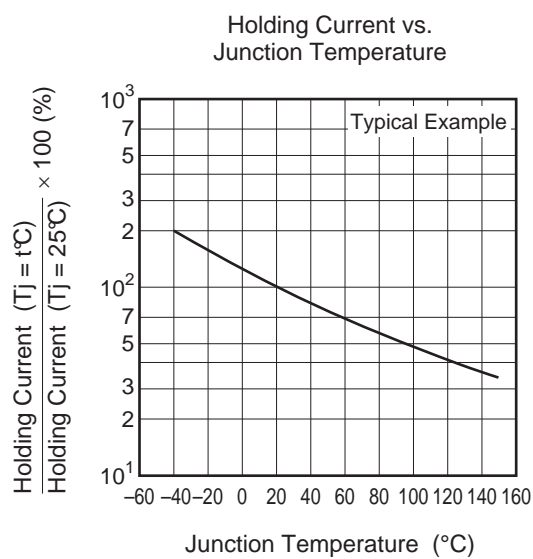
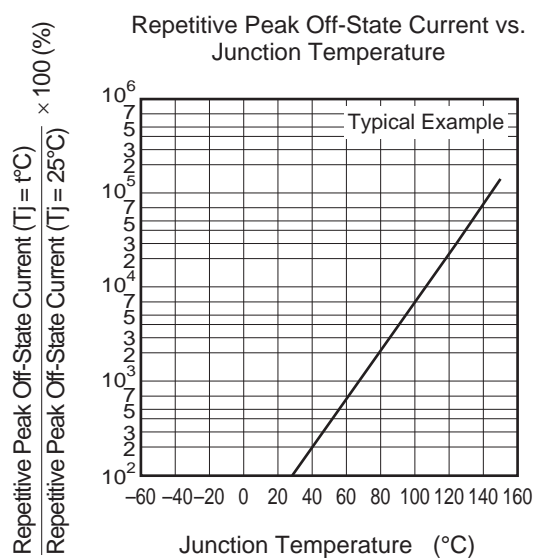
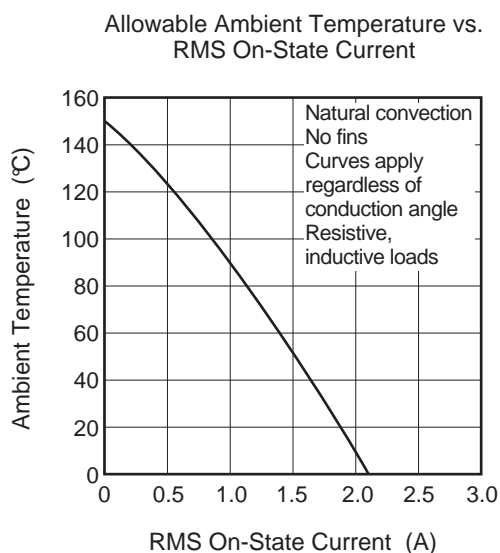
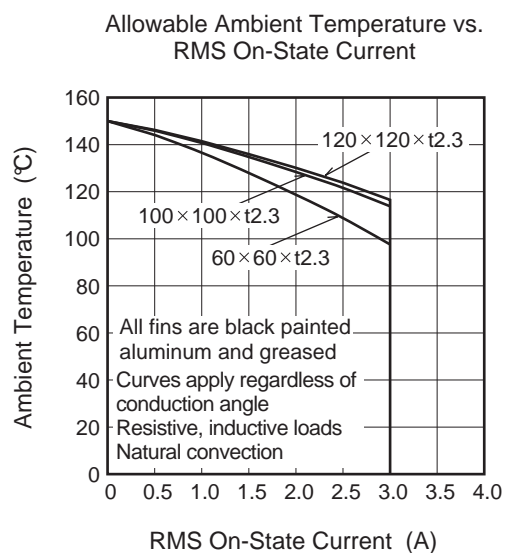
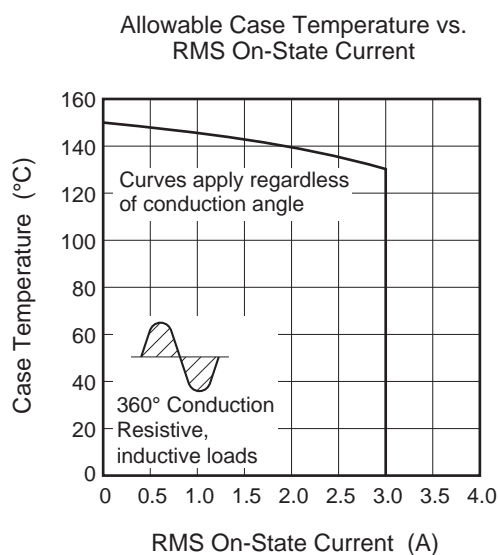
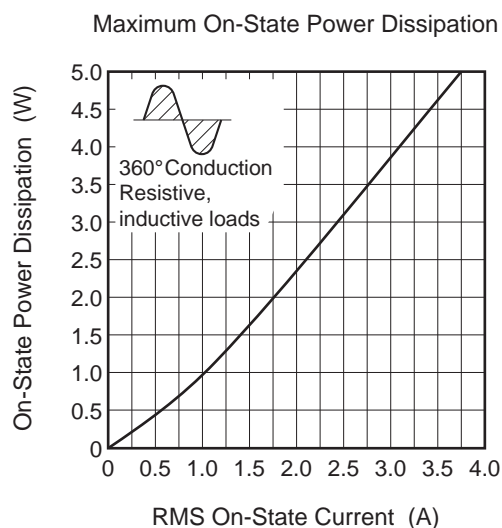
3. The contact thermal resistance $R_{\text{th (c-f)}}$ in case of greasing is 0.5°C/W .

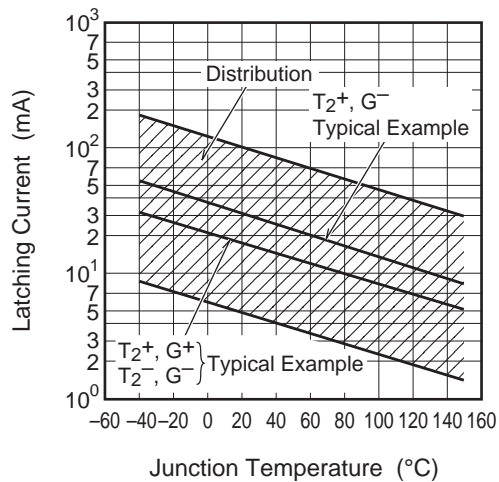
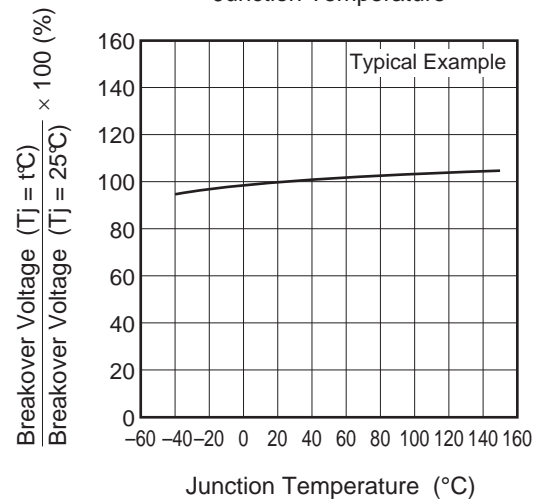
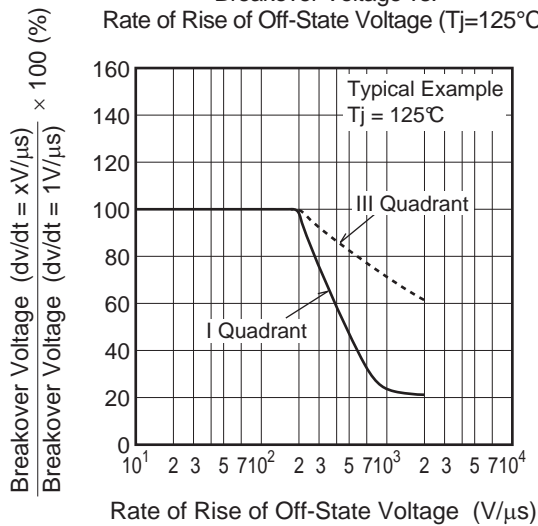
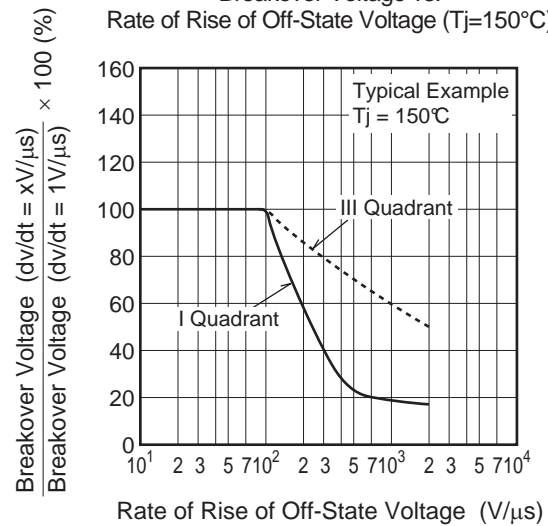
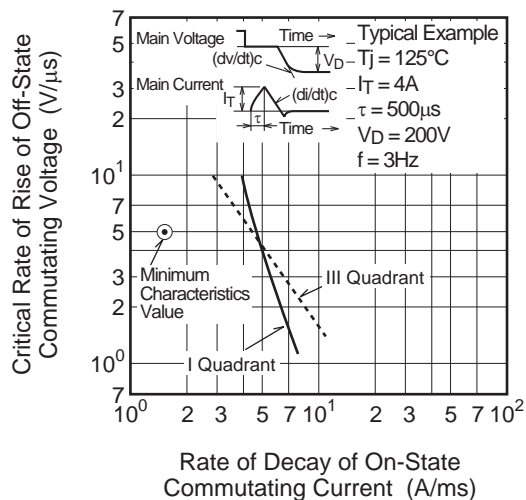
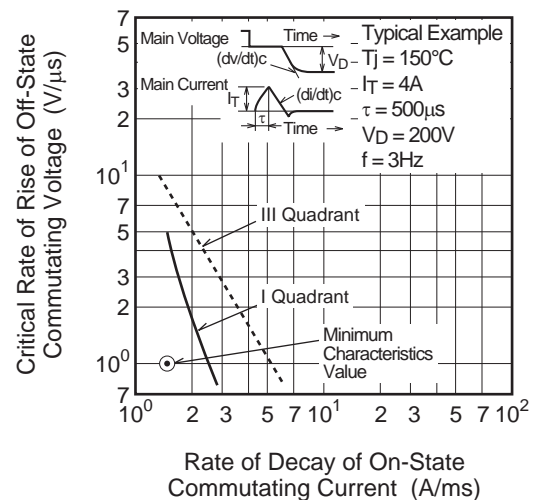
4. Test conditions of the critical-rate of rise of off-state commutation voltage is shown in the table below.

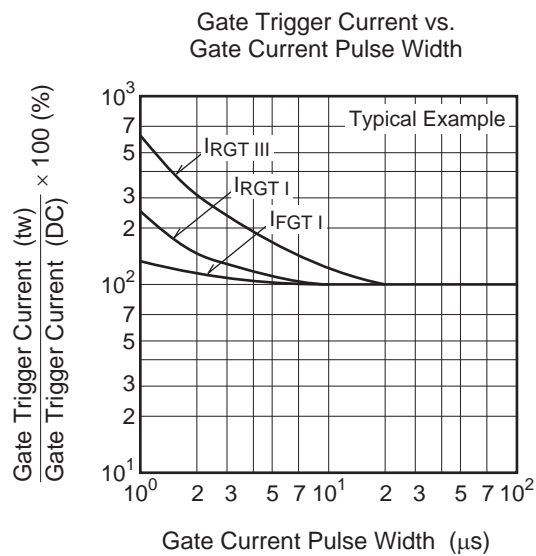
Test conditions	Commutating voltage and current waveforms (inductive load)
1. Junction temperature $T_j = 125^\circ\text{C}/150^\circ\text{C}$ 2. Rate of decay of on-state commutating current $(di/dt)_c = -1.5\text{ A/ms}$ 3. Peak off-state voltage $V_D = 400\text{ V}$	

Performance Curves

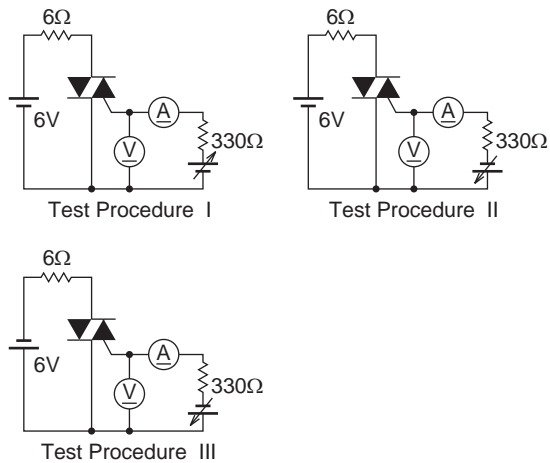




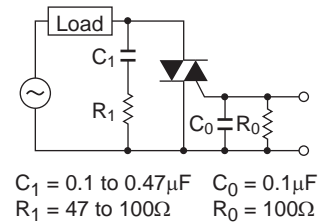
Latching Current vs.
Junction TemperatureBreakover Voltage vs.
Junction TemperatureBreakover Voltage vs.
Rate of Rise of Off-State Voltage ($T_j=125^{\circ}\text{C}$)Breakover Voltage vs.
Rate of Rise of Off-State Voltage ($T_j=150^{\circ}\text{C}$)Commutation Characteristics ($T_j=125^{\circ}\text{C}$)Commutation Characteristics ($T_j=150^{\circ}\text{C}$)



Gate Trigger Characteristics Test Circuits



Recommended Circuit Values Around The Triac



Package Dimensions

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]	Unit: mm
TO-220FL	—	PRSS0003AF-A	TO-220FL	1.5g	

Technical drawing of the BCR3LM-12LB TO-220FL package showing dimensions in mm:

- Top View:**
 - Overall width: 10.0 ± 0.3
 - Overall height: 15.0 ± 0.3
 - Distance from top edge to mounting hole center: 3.0 ± 0.3
 - Distance from side edge to mounting hole center: 6.5 ± 0.3
 - Mounting hole diameter: $\phi 3.2 \pm 0.2$
- Side View:**
 - Overall height: 2.8 ± 0.2
- Lead View:**
 - Lead length: 12.5 ± 0.5
 - Lead thickness: 0.40 ± 0.15
 - Lead width at base: 2.54 ± 0.25
 - Lead width at top: 2.54 ± 0.25
 - Lead thickness at base: 0.75 ± 0.15
 - Lead thickness at top: 1.15 ± 0.2
 - Lead thickness at middle: 1.15 ± 0.2
 - Lead thickness at bottom: 2.6 ± 0.2
 - Lead thickness at top: 4.5 ± 0.2

Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Plastic Magazine (Tube)	50	Type name	BCR3LM-12LB
Lead form	Plastic Magazine (Tube)	50	Type name – Lead forming code	BCR3LM-12LB-A8

Note: Please confirm the specification about the shipping in detail.

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